PRODUCT BRIEF

Intel[®] Wireless-AC 9461 1st Generation Integrated¹ Intel Wireless 802.11ac, Dual Band, 1x1 Wi-Fi + Bluetooth[®] 5, Single Antenna



Intel[®] Wireless-AC 9461

Integrated Wi-Fi and Bluetooth[®]. Optimized Solution for System Design.



Intel[®] Wireless-AC 9461 adapter is a CRF² (Companion RF module) supporting the 1st generation integrated Intel wireless 802.11ac solution comprised of CNVi³ and a CRF. The solution provides Bluetooth[®] 5 and 1x1 802.11ac Wi-Fi including wave 2 features such as downlink MU-MIMO. It is a single antenna CRF and more cost-effective than the previous-gen Intel 802.11ac 1x1 products. Combined with Intel[®] Core[™] processors and exceptional Intel wireless innovations, the Intel Wireless-AC 9461 dramatically improves your connected experience at home, work or on the go.

1 ST GENERATION INTEGRATED 802.11AC WIRELESS		
Faster Speed Better Coverage Larger Capacity 802.11ac, 1x1, Dual Band, 80MHz, MU-MIMO	Delivers up to 3x faster Wi-Fi speed (up to 433 Mbps) than 802.11n, with up to 3x bandwidth for more users and devices. ⁴ Advanced optional 802.11ac specification features and improved RF KPIs that enhance channel reliability and Wi-Fi performance resulting in better coverage and user experience. Intel [®] Wireless- AC 9461 enables smooth streaming of high-resolution videos, fewer dropped connections and less congestion, and fast speed farther away from the router.	
	Downlink MU-MIMO allows an access point to simultaneously transmit data to multiple clients and can improve overall downlink network capacity potentially by over 3x. ⁵	
Bluetooth® 5	Bluetooth [®] 5 provides 4x ⁶ range over Bluetooth [®] 4.2 with the same power, enabling coverage throughout the home. Bluetooth [®] 5 also doubles the transmit speed for faster transmissions, thereby reducing the overall power. ⁶ Bluetooth [®] 5 also adds new enhanced data broadcasting enabling seamless services such as location-based services and simpler pairing for Bluetooth [®] wireless technology enabled products.	
Microsoft Windows* 10 Ready	Full support for latest Microsoft Windows* 10 OS.	
Form Factors (M.2 2230 and 1216)	M.2 2230 modules enable system configuration and platform usage flexibility with the use of a standard Key E socket for attaching the module.	
	M.2 1216 modules enable platform design optimization with the use of an Intel [®] CNVi interface between the integrated MAC and integrated Intel [®] Wireless-AC 9461 module, providing savings on motherboard space, BOM, PCIe and DP lanes, plus allowing for flexible motherboard routing up to 10".	

EXPERIENCE THE INTEL[®] WIRELESS-AC 9461 DIFFERENCE

Worldwide Regulatory Support Intel® Dynamic Regulatory Solution	Enables worldwide regulatory compliance on a single adapter SKU. The Intel® Wireless-AC 9461 detects its location and automatically optimizes the Wi-Fi settings to local regulatory requirements, maximizing performance in each geography, simplifying travel experience and global enterprise procurement. Future regulatory changes are easily managed during the product life cycle.
Wireless Functionality in Pre-boot Environment	Support for Wi-Fi network and Bluetooth [®] Low Energy Human Interface Device (HID) connectivity in the platform's Unified Extensible Firmware Interface (UEFI) environment during its boot stage. This capability enables use cases like OS recovery over Wi-Fi and Bluetooth [®] Low Energy-based keyboard and mouse connectivity in this pre-boot environment.
Wirelessly Project to the Big Screen	Watch your 2 in 1 or laptop content instantly without wires on the big HD screen with stunning image clarity and sound using Wi-Fi Miracast*. Stream movies, videos, games, photos, connect with friends, and more—experience it all, bigger and better than ever before.

INTEL® WIRELESS-AC 9461 TECHNICAL SPECIFICATIONS

GENERAL				
Dimensions (W x H x D)	(Bottom Side)]	M.2 2230: 22 mm x 30 mm x 2.4 mm [1.5mm Max (Top Side)/0.1mm Max (Bottom Side)] M.2 1216: 12 mm x 16 mm x 1.57 (+-0.08) mm		
Weight	M.2 2230: 2.70g M.2 1216: 0.7g	M.2 2230: 2.70g		
Antenna Diversity	Supported	Supported		
Radio ON/OFF Control	Supported	Supported		
Connector Interface	M.2: CNVio	M.2: CNVio		
Operating Temperature (Adapter Shield)	0°C to +80°C			
Humidity Non-Operating	50% to 90% RH	50% to 90% RH noncondensing (at temperatures of 25°C to 35°C)		
Operating Systems	Microsoft Windo	Microsoft Windows* 10, Linux* (limited feature support), Chrome		
Wi-Fi Alliance		Wi-Fi CERTIFIED* a/b/g/n/ac with wave 2 features, WMM*, WMM-PS*, WPA*, WPA2*, WPS2*, Protected Management Frames, Wi-Fi Miracast* as Source, and Wi-Fi Direct*		
IEEE WLAN Standard		IEEE 802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w; 802.11r, 802.11k, 802.11v pending OS support; Fine Timing Measurement based on 802.11REVmc		
Roaming ⁷	Supports seamle	Supports seamless roaming between access points		
Bluetooth®	Bluetooth [®] 5			
SECURITY FEATURES ⁸				
Authentication	WPA* and WPA2*, 802.1X (EAP-TLS, TTLS, PEAP, EAP-SIM, EAP-AKA, EAP-AKA')			
Authentication Protocols		PAP, CHAP, TLS, MS-CHAP*, MS-CHAPv2		
Encryption Wi-Fi Direct* Encryption and		64-bit and 128-bit WEP, TKIP, 128-bit AES-CCMP WPA2-PSK, AES-CCMP		
Authentication				
COMPLIANCE				
Regulatory U.S. Government		For a list of country approvals, please contact your local Intel representatives.		
Product Safety	,	FIPS [®] , FISMA UL, C-UL, CB (IEC 60950-1)		
PRODUCT NAME	MODEL NUM	BER VERSION		
Intel® Wireless-AC 9461	9461NGW	802.11ac wave2, 1x1, Bluetooth® 5, PCIe, USB, M.2 2230, Single Antenna		
	9461D2W	802.11ac wave2, 1x1, Bluetooth® 5, PCIe, USB, M.2 1216, Single Antenna		





For more information on Intel[®] Wireless products, visit intel.com/wireless

- ¹ Integrated: Solution comprised of CNVi and a CRF
- ² CRF: Companion RF module in M.2 form factor supporting integrated solution
- ³ CNVi: Refers to the integrated wireless IP portion residing in the SOC/PCH
- ⁴ Compared to 802.11n 40MHz channels, 802.11ac 80MHz provides 3x more bandwidth per stream (Max data rate for 802.11n 40MHz channels is 150 Mbps; Max data rate for 802.11ac 80Mhz channels is 433 Mbps).
- ⁵ 802.11ac downlink MU-MIMO technology allows concurrently serving multiple devices simultaneously, in turn increasing network capacity potentially by over 3x while improving per-user throughput based on industry standards.
- ⁶ Bluetooth[®] 5 Specifications, www.bluetooth.com/~/media/files/specification/bluetooth-5-faq.ashx?la=en
- ⁷ Roaming is supported only within each respective band and mode of access points.
- ⁸ Some security solutions may not be supported by your device operating system and/or by your device manufacturer. Check with your device manufacturer for details on availability.
- 9 Microsoft Windows* 10.

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